









### **RT9058**

# 36V, 2μA I<sub>Q</sub>, 100mA Low Dropout Voltage Linear Regulator

### 1 General Description

The RT9058 is a low-dropout (LDO) linear voltage regulator featuring high input voltage, low dropout voltage, ultra-low operating current, and compact packaging. With a quiescent current as low as 2µA, the RT9058 is particularly suitable for battery-powered devices.

The RT9058's stability is easily maintained with a variety of output capacitors, including tiny ceramic capacitors, across its wide input voltage range of 3.5V to 36V and load current range of 0mA to 100mA. The RT9058 offers commonly output voltages of 2.5V, 3V, 3.3V, 5V, 6V, 9V, and 12V.

The recommended junction temperature range is -40°C to 125°C, and the ambient temperature range is -40°C to 85°C.

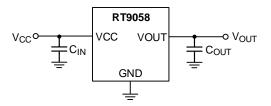
### 2 Features

- 2µA Quiescent Current
- ±2% Output Accuracy
- 100mA Output Current
- 3.5V to 36V Input Voltage Range
- Dropout Voltage:
  - ▶ 0.35V at 10mA/VCC 5V
  - ▶ 0.5V at 10mA/VCC 3.5V
- Fixed Output Voltage: 2.5V, 3V, 3.3V, 5V, 6V, 9V, 12V
- Stable with Ceramic or Tantalum Capacitors
- Current Limit Protection
- Over-Temperature Protection
- SOT-23-3, SOT-89-3 Packages

### 3 Applications

- Portable, Battery Powered Equipment
- Ultra Low Power Microcontrollers
- Notebook Computers

### **4 Simplified Application Circuit**



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# **5 Ordering and Marking Information**

Part Number	Output Voltage	Package	Marking Information
RT9058-25GV		SOT-23-3	00=
RT9058-25GVL	2.5V	SOT-23-3 (L)	2A=
RT9058-25GX		SOT-89-3	00=
RT9058-30GV		SOT-23-3	2H=
RT9058-30GVL	3.0V	SOT-23-3 (L)	2G=
RT9058-30GX		SOT-89-3	10=
RT9058-33GV		SOT-23-3	03=
RT9058-33GVL	3.3V	SOT-23-3 (L)	2B=
RT9058-33GX		SOT-89-3	01=
RT9058-50GV		SOT-23-3	06=
RT9058-50GVL	5.0V	SOT-23-3 (L)	2C=
RT9058-50GX		SOT-89-3	02=
RT9058-60GV		SOT-23-3	0R=
RT9058-60GVL	6.0V	SOT-23-3 (L)	2D=
RT9058-60GX		SOT-89-3	0D=
RT9058-90GV		SOT-23-3	0N=
RT9058-90GVL	9.0V	SOT-23-3 (L)	2E=
RT9058-90GX		SOT-89-3	0C=
RT9058-C0GV		SOT-23-3	OM=
RT9058-C0GVL	12.0V	SOT-23-3 (L)	2F=
RT9058-C0GX		SOT-89-3	0B=

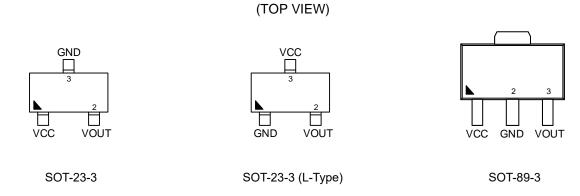


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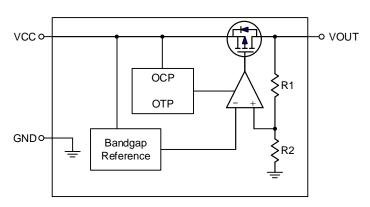
## **6 Pin Configuration**



## 7 Functional Pin Description

	Pin No.		Pin Name	Pin Function
SOT-23-3	SOT-23-3 (L-Type)	SOT-89-3	riii ivaille	Fin Function
1	3	1	VCC	Supply input. A general $1\mu F$ ceramic capacitor should be placed as close as possible to this pin for better noise rejection.
2	2	3	VOUT	LDO output pins. A ceramic capacitor of $2.2\mu F$ or larger (with $1\mu F$ or greater effective capacitance) is required for stability. The output capacitor should be placed as close to the device as possible to minimize the resistive and inductive impedance between the VOUT pin and the load.
3	1	2	GND	The exposed pad should be soldered to a large PCB area and connected to GND to achieve maximum power dissipation.

# 8 Functional Block Diagram



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### 9 Absolute Maximum Ratings

#### (Note 1)

VCC to GND	-0.3V to 40V
VOUT to GND	
RT9058-C0/RT9058-60/RT9058-90	-0.3V to 15V
RT9058-25/RT9058-30/RT9058-33/RT9058-50	-0.3V to6V
• VOUT to VCC	-40V to 0.3V
<ul> <li>Power Dissipation, PD @ TA = 25°C</li> </ul>	
SOT-23-3	0.41W
SOT-89-3	20.6W
Package Thermal Resistance (Note 2)	
• Fackage Thermal Resistance (Note 2)	
SOT-23-3, θJA	243.3°C/W
<u> </u>	
SOT-23-3, θJA	167.7°C/W
SOT-23-3, θJASOT-89-3, θJA	167.7°C/W
SOT-23-3, θJA	167.7°C/W 260°C -40°C to 150°C
SOT-23-3, θJA SOT-89-3, θJA  • Lead Temperature (Soldering, 10 sec.)  • Junction Temperature	167.7°C/W 260°C -40°C to 150°C

- **Note 1**. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2.  $\theta_{JA}$  is measured under natural convection (still air) at  $T_A$  = 25°C with the component mounted on a high effective-thermal-conductivity four-layer test board on a JEDEC 51-7 thermal measurement standard
- Note 3. Devices are ESD sensitive. Handling precautions are recommended.

## 10 Recommended Operating Conditions

### (Note 4)

- Note 4. The device is not guaranteed to function outside its operating conditions.



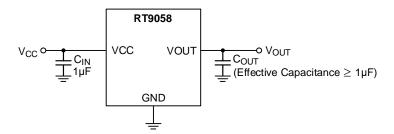
### 11 Electrical Characteristics

((V<sub>OUT</sub> +1) < V<sub>CC</sub> < 36V,  $T_A$  = 25°C, unless otherwise specified.)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Output Voltage Range			2.5		12	V
DC Output Accuracy		ILOAD = 10mA	-2		2	%
Dropout Voltage		ILOAD = 10mA		0.3	0.5	V
VCC Ouisesent Current		ILOAD = 0mA, VOUT $\leq$ 5.5V, VCC = 12V		2	3.5	
VCC Quiescent Current	IQ	ILOAD = 0mA, VOUT > 5.5V, VCC = 12V		3.5	5	μΑ
Line Regulation		ILOAD = 10mA	-	0.2	0.5	%
Load Regulation		0 < ILOAD < 50mA, VCC = VOUT + 2V	-0.5		0.5	%
Output Current Limit		VOUT = 0.5 x VOUT (normal)	115	175	300	mA
Dower Cumply Dejection Date	DCDD	f = 100Hz, Iout = 25mA		-70		
Power Supply Rejection Rate	PSRR	f = 100kHz, I <sub>OUT</sub> = 25mA		-40		dB
Output Noise Voltage BW = 10Hz - 100kHz	Von	COUT = 1μF		27 x Vout		μVRMS
Thermal Shutdown Temperature		ILOAD = 30mA		150		°C
Thermal Shutdown Hysteresis				20		°C



### 12 Typical Application Circuit



For stability requirements, COUT must have a minimum value of  $1\mu F$  for the RT9058, and this capacitance must be maintained across the entire expected operating temperature range. It should also be located as close as possible to the regulator.

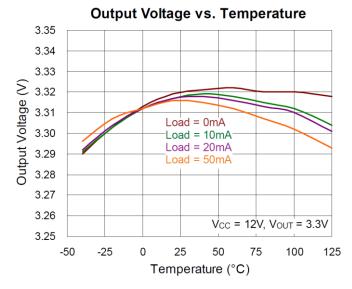
**Note 5**. All input and output capacitive parameters recommended here refer to the effective capacitance. It is necessary to account for any derating effects, such as DC bias, to accurately consider the effective capacitance.

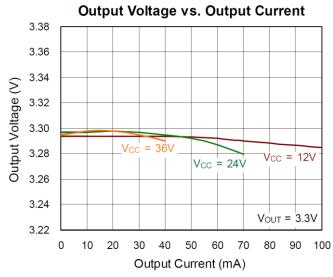
**Table 1. Recommended External Components** 

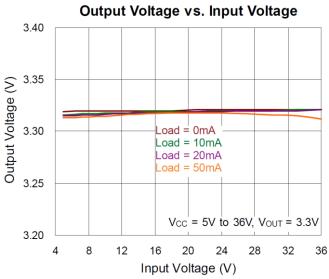
Component	Description	Vendor P/N
Cin	1μF, 50V, X7R, 1206	GCJ31CR71H105KA12 (Murata)
Соит	2.2μF, 16V, X7R, 0805	GGM21BR71C225KA64 (Murata)

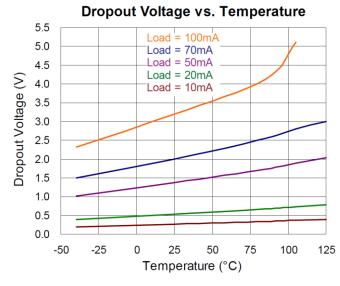


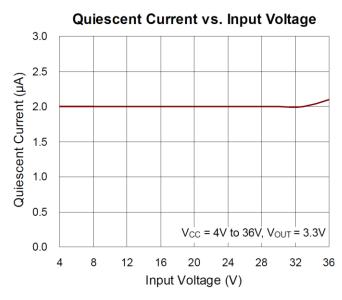
### 13 Typical Operating Characteristics

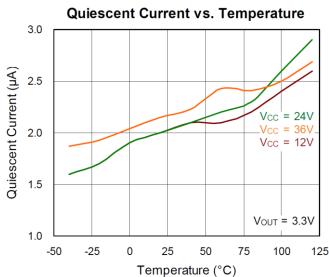




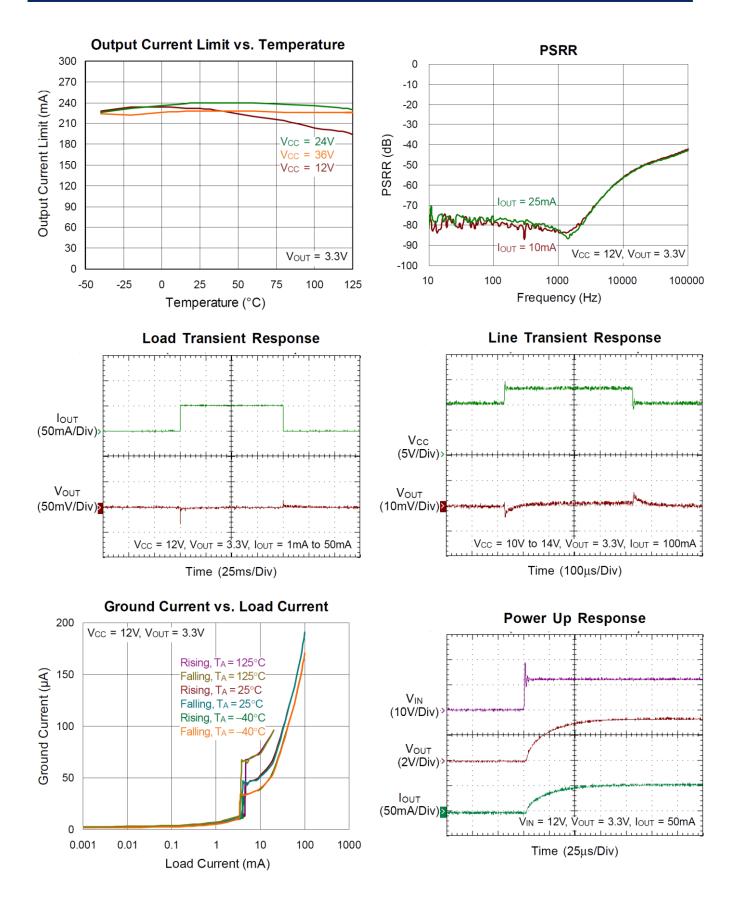












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### 14 Operation

The RT9058 is a high-input-voltage linear regulator designed specifically to minimize the need for external components. The input voltage range extends from 3.5V to 36V. The minimum output capacitance required for stable operation is an effective  $1\mu F$ , considering the capacitor's temperature and voltage coefficient. For normal power-on operation, the slew rate of the VCC rising time should be slower than  $45\text{mV}/\mu s$ .

#### 14.1 Error Amplifier

The Error Amplifier compares the feedback voltage from an internal voltage divider with an internal reference voltage. It then adjusts the gate voltage of the P-MOSFET to maintain output voltage regulation.

#### 14.2 Current Limit Protection

The RT9058 features a current limit function to prevent damage from output overload or short-circuit conditions. The output current is monitored by an internal sensing transistor.

#### 14.3 Over-Temperature Protection

The over-temperature protection function shuts off the P-MOSFET when the internal junction temperature exceeds 150°C (typical) or the output current exceeds 4mA. Once the junction temperature decreases by approximately 20°C, the regulator will automatically resume normal operation.



### 15 Application Information

#### (Note 6)

Like any low-dropout linear regulator, the RT9058 requires proper selection of external input and output capacitors for stability and performance. An input capacitor of  $1\mu F$  or larger should be used and placed close to the IC's VCC and GND pins. Any output capacitor that meets the minimum Equivalent Series Resistance (ESR) of  $1m\Omega$  and has an effective capacitance greater than  $1\mu F$  may be used. It should be placed close to the IC's VOUT and GND pins.

#### 15.1 CIN and COUT Selection

The RT9058 is designed to support low-series-resistance (ESR) ceramic capacitors. Because of their good capacitive stability across different temperatures, X7R, X5R, and COG-rated ceramic capacitors are recommended. The use of Y5V-rated capacitors is not recommended due to their large capacitance variations.

However, the capacitance of ceramic capacitors varies with operating voltage and temperature, which design engineers need to consider. It is customary to derate ceramic capacitors by 50%. To ensure stability, an output ceramic capacitor of  $2.2\mu F$  or greater (or  $1\mu F$  of effective capacitance) is suggested. The input capacitor should be selected to minimize the transient voltage drop during load current steps; at least a  $2.2\mu F$  input capacitor is highly recommended to maintain minimal input impedance. If there is significant inductance in the traces between the RT9058 input pin and the power supply, a fast load transient may induce voltage ringing at the VIN level that exceeds the device's absolute maximum rating, potentially damaging it. Adding more input capacitors can help to restrict the ringing and keep it within the device's absolute maximum ratings. These capacitors should be placed as close as possible to the pins for optimal performance and stability.

#### 15.2 Dropout Voltage

The dropout voltage refers to the voltage difference between the VIN and VOUT pins while operating at a specific output current. The dropout voltage VDROP also can be expressed as the voltage drop on the pass-FET at a specific output current (IRATED) when the pass-FET is fully operating in the ohmic region and can be characterized as a resistance RDS(ON). Thus, the dropout voltage can be defined as VDROP = VIN - VOUT = RDS(ON) x IRATED. For normal operation, the suggested LDO operating range is VIN > VOUT + VDROP to ensure good transient response and PSRR performance. However, operation in the ohmic region will severely degrade the performance severely.

#### 15.3 Thermal Considerations

The junction temperature should never exceed the absolute maximum junction temperature T<sub>J(MAX)</sub>, listed under Absolute Maximum Ratings, to avoid permanent damage to the device. The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction and ambient temperatures. The maximum power dissipation can be calculated using the following formula:

 $PD(MAX) = (TJ(MAX) - TA) / \theta JA$ 

where  $T_{J(MAX)}$  is the maximum junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction-to-ambient thermal resistance.

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For continuous operation, the maximum operating junction temperature indicated under Recommended Operating Conditions is 125°C. The junction-to-ambient thermal resistance, θJA, is highly package dependent. For a SOT-23-3 package, the thermal resistance, θJA, is 243.3°C/W on a standard JEDEC 51-7 high effective-thermalconductivity four-layer test board. For a SOT-89-3 package, the thermal resistance,  $\theta$ JA, is 167.7°C/W on a standard JEDEC 51-7 high effective-thermal-conductivity four-layer test board. The maximum power dissipation at  $T_A = 25^{\circ}C$  can be calculated as below:

 $PD(MAX) = (125^{\circ}C - 25^{\circ}C) / (243.3^{\circ}C/W) = 0.41W$  for a SOT-23-3 package.

 $PD(MAX) = (125^{\circ}C - 25^{\circ}C) / (167.7^{\circ}C/W) = 0.6W$  for a SOT-89-3 package.

The maximum power dissipation depends on the operating ambient temperature for the fixed TJ(MAX) and the thermal resistance,  $\theta$ JA. The derating curves in Figure 1 allow the designer to see the effect of rising ambient temperature on the maximum power dissipation.

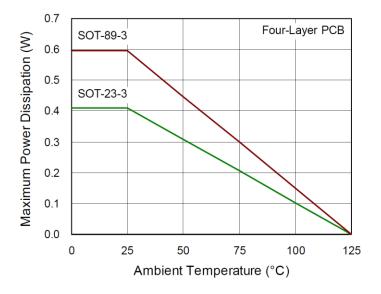
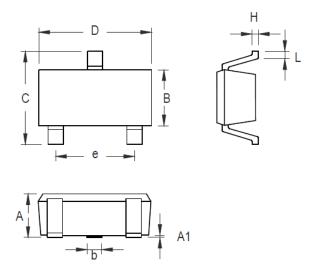


Figure 1. Derating Curve of Maximum Power Dissipation

Note 6. The information provided in this section is for reference only. The customer is solely responsible for the designing, validating, and testing your product incorporating Richtek's product and ensure such product meets applicable standards and any safety, security, or other requirements.



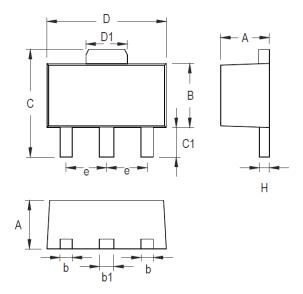
### 16 Outline Dimension



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Min Max		Max	
А	0.889	1.295	0.035	0.051	
A1	0.000	0.152	0.000	0.006	
В	1.397	1.803	0.055	0.071	
b	0.356	0.508	0.014	0.020	
С	2.591	2.997	0.102	0.118	
D	2.692	3.099	0.106	0.122	
е	1.803	2.007	0.071	0.079	
Н	0.080	0.254	0.003	0.010	
L	0.300	0.610	0.012	0.024	

**SOT-23-3 Surface Mount Package** 



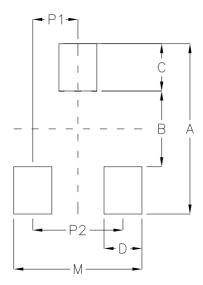


Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	1.397	1.600	0.055	0.063	
b	0.356	0.483	0.014	0.019	
В	2.388	2.591	0.094	0.102	
b1	0.406	0.533	0.016	0.021	
С	3.937	4.242	0.155	0.167	
C1	0.787	1.194	0.031	0.047	
D	4.394	4.597	0.173	0.181	
D1	1.397	1.753	0.055	0.069	
е	1.448	1.549	0.057	0.061	
Н	0.356	0.432	0.014	0.017	

3-Lead SOT-89 Surface Mount Package

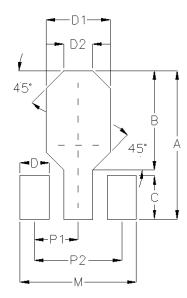


# 17 Footprint Information



Dookogo	Footprint Dimension (mm)							Tolerance	
Package	Pin	P1	P2	Α	В	С	D	М	Tolerance
TSOT-23/SOT-23	3	0.95	1.90	3.60	1.60	1.00	0.80	2.70	±0.10





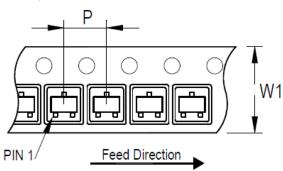
Dookogo	Number of		Footprint Dimension (mm)								Toloropoo
Package	Pin	P1	P1 P2 A B C D D1 D2 M						Tolerance		
SOT-89	3	1.50	3.00	5.10	3.40	1.50	1.00	2.20	1.00	4.00	±0.10

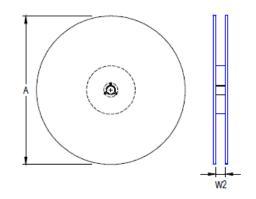


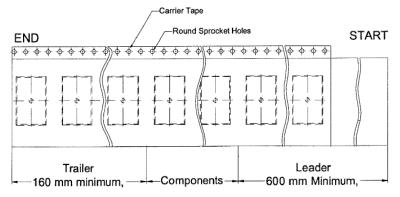
## 18 Packing Information

#### 18.1 Tape and Reel Data - SOT-23-3

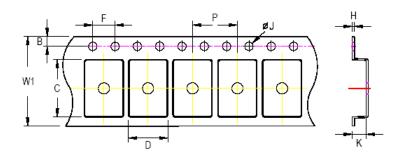
### **SOT/TSOT-23-3:**







Package Type	Tape Size (W1) (mm)	Pocket Pitch (P) (mm)	Reel Si	ze (A)	Units per Reel	Trailer (mm)	Leader (mm)	Reel Width (W2) Min./Max. (mm)
SOT/TSOT- 23-3	8	4	180	7	3,000	160	600	8.4/9.9



C, D, and K are determined by component size. The clearance between the components and the cavity is as follows:

- For 8mm carrier tape: 0.5mm max.

Tape Size	W1	F	)	В			F		ØJ	
Tape Size	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Max.
8mm	8.3mm	3.9mm	4.1mm	1.65mm	1.85mm	3.9mm	4.1mm	1.5mm	1.6mm	0.6mm

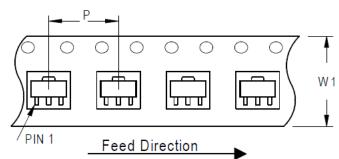
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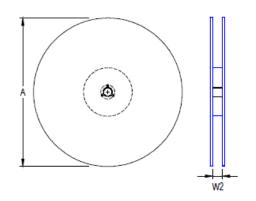
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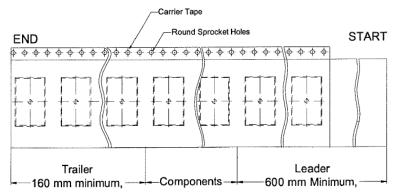


#### 18.2 Tape and Reel Data - SOT-89-3

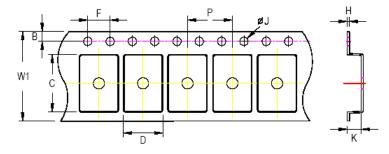
#### SOT-89:







Package Type	Tape Size (W1) (mm)	Pocket Pitch (P) (mm)	Reel Size (A) (mm) (in)		Units per Reel	Trailer (mm)	Leader (mm)	Reel Width (W2) Min./Max. (mm)
SOT-89	12	8	180	7	1,000	160	600	12.4/14.4



C, D, and K are determined by component size. The clearance between the components and the cavity is as follows:

- For 12mm carrier tape: 0.5mm max.

Tape Size	W1	F	)	В		F		ØJ		Н
Tape Size	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Max.
12mm	12.3mm	7.9mm	8.1mm	1.65mm	1.85mm	3.9mm	4.1mm	1.5mm	1.6mm	0.6mm



### 18.3 Tape and Reel Packing - SOT-23-3

Step	Photo/Description	Step	Photo/Description
1	Reel 7"	4	RICHTER CARRY TO THE PROPERTY OF THE PROPERTY
2	HIC & Desiccant (1 Unit) inside	5	12 inner boxes per outer box
3	Caution label is on backside of Al bag	6	Outer box Carton A

Container	R	eel	Вох			Carton			
Package	Size	Units	Item	Reels	Units	Item	Boxes	Unit	
007/7007 00 0	7"	2 000	Box A	3	9,000	Carton A	12	108,000	
SOT/TSOT-23-3	1	3,000	Box E	1	3,000	For Cor	nbined or Partial	Reel.	

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#### Tape and Reel Packing - SOT-89-3 18.4

Step	Photo/Description	Step	Photo/Description
1	Reel 7"	4	3 reels per inner box Box A
2	HIC & Desiccant (1 Unit) inside	5	12 inner boxes per outer box
3	Caution label is on backside of Al bag	6	Outer box Carton A

Container	R	eel	Вох			Carton			
Package	Size	Units	Item	Reels	Units	Item	Boxes	Unit	
00. TO	7"	4.000	Box A	3	3,000	Carton A	12	36,000	
SOT-89	7	1,000	Box E	1	1,000	For Co	mbined or Partia	l Reel.	



### 18.5 Packing Material Anti-ESD Property

Surface Resistance	Aluminum Bag	Reel	Cover tape	Carrier tape	Tube	Protection Band
$\Omega$ /cm <sup>2</sup>	10 <sup>4</sup> to 10 <sup>11</sup>					

### **Richtek Technology Corporation**

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19 Datasheet Revision History

Version	Date	Description	Item
03	2024/3/26	Modify	General Description on P1 Functional Pin Description on P4 Typical Application Circuit on P7 Application Information on P11 Footprint Information on P15, 16 Packing Information on P17 to 21

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